description

SN5485, SN54LS85, SN54S85 SN7485, SN74LS85, SN74S85 4-BIT MAGNITUDE COMPARATORS

MARCH 1974 - REVISED MARCH 1988

	TYPICAL	TYPICAL
TYPE	POWER	DELAY
	DISSIPATION	(4-BIT WORDS)
′85	275 mW	23 пѕ
'L\$85	52 mW	24 ns
'S85	365 mW	11 ns

These four-bit magnitude comparators perform

comparison of straight binary and straight BCD (8-4-2-1)

codes. Three fully decoded decisions about two 4-bit

words (A, B) are made and are externally available at three

outputs. These devices are fully expandable to any number of bits without external gates. Words of greater

length may be compared by connecting comparators in

cascade. The A > B, A < B, and A = B outputs of a stage handling less-significant bits are connected to the corresponding A > B, A < B, and A = B inputs of the next stage handling more-significant bits. The stage handling the least-significant bits must have a high-level

voltage applied to the A = B input. The cascading paths

of the '85, 'LS85, and 'S85 are implemented with only

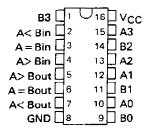
a two-gate-level delay to reduce overall comparison times

for long words. An alternate method of cascading which

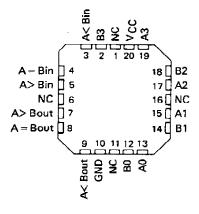
further reduces the comparison time is shown in the

typical application data.

SN5485, SN54LS85, SN54S85 . . . J OR W PACKAGE SN7485 . . . N PACKAGE SN74LS85, SN74S85 . . . D OR N PACKAGE (TOP VIEW)



SN54LS85, SN54S85 . . . FK PACKAGE (TOP VIEW)

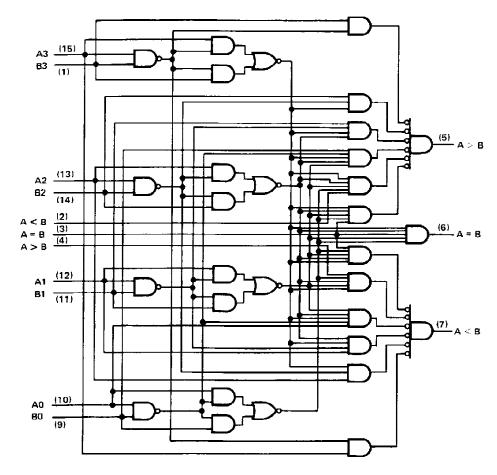


NC - No internal connection

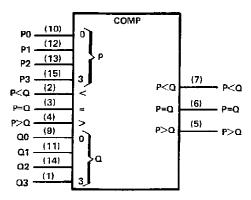
FUNCTION TABLE

		ARING UTS			CASCADING INPUTS			OUTPUTS	
A3, B3	A2, B2	A1, B1	A0, B0	A > B	A < B	A = B	A > B	A < B	A = B
A3 > B3	X	X	х	Х	×	X	н	L	Ļ
A3 < B3	×	x	×	x	x	x	l L	н	L
A3 = B3	A2 > B2	×	×	×	×	×	н	L	L
A3 = B3	A2 < B2	×	x	×	x	×	L	н	L
A3 = B2	A2 = B2	A1 > B1	х	×	x	x	н	L	L
A3 = B3	A2 = B2	A1 < B1	X .	l x	×	×	L	н	L
A2 = B3	A2 = B2	A1 = 81	A0 > B0	×	×	×	н	L	L
A3 = B3	A2 = B2	A1 = B1	A0 < B0	x	x	x	L	H	L
A3 = B3	A2 = B2	A1 = 81	A0 = B0	H	L	L	Н	L	L
A3 - B3	A2 = B2	A1 = B1	AO = 80	L	Н	L	Ĺ	н	L
A3 = B3	A2 = B2	A1 = B1	AO = 80	x	×	н	L	L	н
A3 = 83	A2 = B2	A1 = B1	AO = BO	н	н	L	ا	L	L
A3 = B3	A2 = B2	A1 = B1	AO = BO	L	Ł	L	н	н	L

logic diagrams (positive logic)



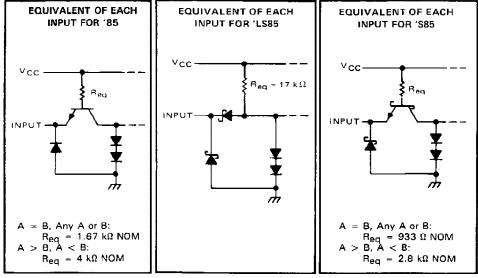
logic symbol†

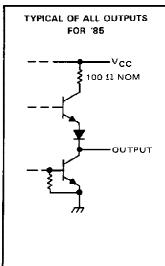


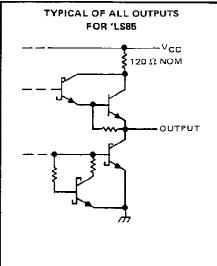
 $^{^{\}dagger}$ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for D, J, N, and W packages.

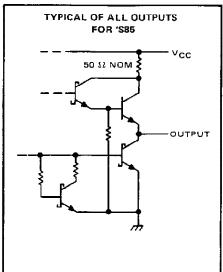


schematics of inputs and outputs









absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

	SN64' SN64S'	SN54LS'	SN74' SN74S'	SN74LS'	UNIT
Supply voltage, VCC (see Note 1)	7	7	7	7	V
Input voltage	5.5	7	5.5	7	V
Interemitter voltage (see Note 2)	5.5		5.5 -		V
Operating free-air temperature range	- 55	to 125	-0	to 70	°C
Storage temperature range	- 65	to 150	- 65	to 150	°C

NOTES: 1. Voltage values, except interemitter voltage, are with respect to network ground terminal.

2. This is the voltage between two emitters of a multiple-emitter input transistor. This rating applies to each A input in conjunction with its respective B input of the '85 and 'S85.

SN5485, SN7485 4-BIT MAGNITUDE COMPARATORS

recommended operating conditions

		SN5485)		SN748	5	UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Supply voltage, V _{CC}	4.5	5	5.5	4.75	5	5,25	٧
High-level output current, IOH			400			-400	μА
Low-level output current, IOL			16			16	mА
Operating free-air temperature, TA	55		125	0		70	°С

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMETER	l	TE	ST CONDIT	IONS†		MIN	TYP‡	мах	UNIT
ViH	High-level input voltage		1				2			V
VIL	Low-level input voltage								8.0	٧
Vik	Input clamp voltage		V _{CC} = MIN,		11 = -1	2 mA			-1.5	V
۷он	High-level output voltage		V _{CC} = MIN, V _{IL} = 0.8 V,		V _{IH} = 2	2 V, -400 μA	2.4	3.4		V
VOL	Low-level output voltage		V _{CC} = MIN, V _{1L} = 0.8 V,		V _{IH} = 2			0.2	0.4	٧
l _l	Input current at maximum in	nput voltage	V _{CC} = MAX,		V ₁ = 5.9	5 V			1	mΑ
ЧН	High-level input current	A < B, A > B inputs	V _{CC} = MAX,		V _I = 2.4				40	μА
111		l all other inputs	1 00						120	
1	Low-level input current	A < B, A > B inputs	Voc - MAY		V ₁ = 0.4	1 1/			-1.6	mΑ
ΊL	FORM-level import content	all other inputs	VCC - WAA,		Ψ ₁ = 0				-4.8	ma
		:	V	V 0		SN5485	-20		-55	
los	Short-circuit output current	3	V _{CC} = MAX,	ΛO = 0		SN7485	-18		-55	mA
ICC	Supply current		VCC = MAX,	See Note 4				55	88	mΑ

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 4: ICC is measured with outputs open, A = B grounded, and all other inputs at 4.5 V.

switching characteristics, VCC = 5 V, TA = 25°C

PARAMETER	FROM INPUT	TO OUTPUT	NUMBER OF GATE LEVELS	TEST CONDITIONS	MIN TY	MAX	דומני
			1		7		
	A A B '	A < B, $A > B$	2		12]
^t PLH	Any A or B data input		3		1.7	26	ns
		A = B	4		23	35	
			1		11		
		A < B, $A > B$	2	CL = 15 pF,	15]
^t PH L	Any A or B data input		3	$R_L = 400 \Omega$,	20	30	ns
		A = B	4	See Note 5	20	30	
tpLH	A < B or A = B	A > B	1	occ Note 5	7	11	ns
tPHL	A < B or A = B	A > B	Ť		11	17	กร
tpLH	A = B	A = B	2		13	20	ns
^t PHL	A = B	A = B	2		11	17	ns
^t PLH	A > B or A = B	A < B	1		7	1 1	ns
tPHL.	A > B or A = 8	A < B	1		11	17	ns

tpLH = propagation delay time, low-to-high-level output

NOTE 5: Load circuits and voltage waveforms are shown in Section 1.



 $^{^{\}ddagger}_{n}$ All typical values are at V_{CC} = 5 V, T_{A} = 25°C.

Not more than one output should be shorted at a time.

tpHL - propagation delay time, high-to-low-level output

recommended operating conditions

	S	N54LS	35	S	N74LS	35	UNIT
	MIN	MOM	MAX	MIN	NOM	MAX	UNII
Supply voltage, VCC	4.5	5	5.5	4.75	5	5.25	V
High-level output current, IOH			-400			-400	μА
Low-level output current, IQL			4			8	mA
Operating free-air temperature, TA	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

		ucted	TEST SOL	inizianat	S	N54LS	5	S	N74LS	35	
	PAHA	METER	TEST CO	NDITIONS†	MIN	TYP‡	MAX	MIN	TYP‡	MAX	TINU
VIH	High-level input	voltage	.,	-	2	-		2			V
VIL	Low-level input	voltage					0.7			0.7	٧
VIK	Input clamp vol	tage	VCC = MIN,	I ₁ = -18 mA			-1.5			-1.5	٧
νон	High-level outp	ut voltage	, -	V _{IH} = 2 V, t _{OH} = -400 μA	2.5	3.4		2.7	3.4		٧
			V _{CC} = MIN,	IOL = 4 mA		0.25	0.4		0.25	0.4	\ \ \
VOL	Low-level outpu	it voitage	V _{IH} = 2 V, V _{IL} = V _{IL} max	IOL = 8 mA					0.35	0.5	1 0
	Input current	A < B, A > B inputs					0.1			0.1	
'1	at maximum input voltage	all other inputs	V _{CC} = MAX,	V _I = 7 V			0.3			0.3	mA
	High-level	A < B, A > B inputs	W = \$10.00	14 0 7 14			20			20	
ин	input current	all other inputs	VCC = MAX,	V ₁ = 2.7 V			60			60	μΑ
	Low-level	A < B, A > B inputs	W - MAY	V 0.411			-0.4			-0.4	
ΙŁ	input current	all other inputs	V _{CC} = MAX,	V _I = 0.4 V			-1.2			-1.2	mA
los	Short-circuit ou	tput current §	V _{CC} = MAX		-20		-100	-20		-100	mA
Icc	Supply current		V _{CC} = MAX,	See Note 4		10.4	20		10.4	20	mΑ

Thor conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ} \text{ C}$

PARAMETER*	FROM	то	NUMBER OF	TEST CONDITIONS	MIN 7	YP I	MAX	UNIT	
	INPUT	OUTPUT	GATE LEVELS					<u> </u>	
			1			14			
	A A B data (A < B, A > B	2			19			
^t PLH	Any A or B data input		3			24	36	ns	
		A = B	4		MIN TYF 14 19 24 27 11 15 20 23 14 11 13 13 14 11	27	45	1	
			1			11			
		A < B, A > B	2	C 15 5		15]	
^t PHL	Any A or B data input		1 3 1 -	$C_L = 15 pF$,		20	30	ns	
		A = B	4	$R_L = 2 k\Omega$	See Note 5			45]
†PLH	A < B or A = B	A > B	1	See Note 5		14	22	ns	
tPHL	A < B or A = B	A > B	1			11	17	ns	
^t PLH	A = B	A = 8	2			13	20	ΠS	
[‡] PHL	A = B	A = B	2		13	13	26	ns	
^t PLH	A > B or A = B	A < B	1			14	22	ns	
tPHL	A > B or A = B	A < B	1			11	17	ns	

 $[\]P_{tPLH}$ = propagation delay time, low-to-high-level output

NOTE 5: Load circuits and voltage waveforms are shown in Section 1.



 $[\]ddagger$ All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 4: Icc is measured with outputs open, A = 8 grounded, and all other inputs at 4.5 V.

tpHL = propagation delay time, high-to-low-level output

SN54S85, SN74S85 **4-BIT MAGNITUDE COMPARATORS**

recommended operating conditions

		SN54S8	5		SN7458	5	110117
	MIN	NOM	MAX	MIN	MOM	MAX	UNIT
Supply voltage, VCC	4.5	5	5.5	4.75	5	5.25	٧
High-level output current, IOH			-1			-1	mΑ
Low-level output current, IOL			20			20	mA
Operating free-air temperature, TA	-55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	PARAMET	ER	TES	T CONDITIONS	S†	MIN	TYP‡	MAX	UNIT
VιΗ	High-level input voltage					2			V
VIL	Low-level input voltage	- · · · · · · · · · · · · · · · · · · ·						0.8	V
VIK	Input clamp voltage		VCC = MIN,	I _I = -18 mA				-1.2	V
V	High lavel output valtage		V _{CC} - MIN,	V _{IH} = 2 V,	SN54S85	2.5	3.4		
νон	High-level output voltage		V _{IL} = 0.8 V,	I _{OH} = -1 mA	SN 74S85	2.7	3.4		٧
VOL	Low-level output voltage		VCC = MIN,	V _{IH} = 2 V,				0.5	v
VOL	Low-level output voltage		V _{IL} = 0.8 V,	IOL = 20 mA		İ		0.5	ľ
Τį	Input current at maximum inp	out voltage	V _{CC} = MAX,	V ₁ = 5.5 V				1	mΑ
1	High-level input current	A < B, A > B inputs	V _{CC} = MAX,	V 2 7 V				50	μА
ΉН	riightiever input current	all other inputs	7 VCC - WAA.	V1 - 2.7 V				150	44
1	Low-level input current	$A \le B$, $A > B$ inputs	Vcc = MAX,	V. = 0.5.V				-2	0
ll.	Cow-level imput current	all other inputs	VCC - IVIAA,	V = 0.5 V				-6	mA
los	Short-circuit output current [§]	· -	V _{CC} = MAX			40		-100	mA
			V _{CC} = MAX,	See Note 4			73	115	
lcc	Supply current		V _{CC} = MAX, See Note 4	T _A = 125°C,	SN54S85W			110	mA

[†]For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

NOTE 4: ICC is measured with outputs open, A = B grounded, and all other inputs at 4.5 V.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

PARAMETER¶	FROM INPUT	TO OUTPUT	NUMBER OF GATE LEVELS	TEST CONDITIONS	MIN TYP	MAX	דואט
		<u> </u>	1		5		
		$A \leq B, A \geq B$	2		7.5]
¹PLH	Any A or B data input		3		10.5	16	ns
		A = B	4	3	12	18]
			1		5.5		
	A A P :	$A \le B$, $A \ge B$	2	C - 15 - C	7		ns
[†] PHL	Any A or B data input		3	C _L = 15 pF,	11	16.5	
		A = B	4	RL = 280 Ω, See Note 5	11	16.5]
[†] PLH	A < B or A = B	A > B	1	See Note 5	5	7.5	ns
tPHL .	A < B or A = B	A > B	1		5.5	8.5	ns
^t PLH	A = B	A = B	2		7	10.5	ns
^t PHL	A = B	A = R	2		5	7.5	กร
tPLH .	A > B or A = B	A < B	1		5	7.5	пş
^t PHL	A > B or A = B	A < B	1		5.5	8.5	nş

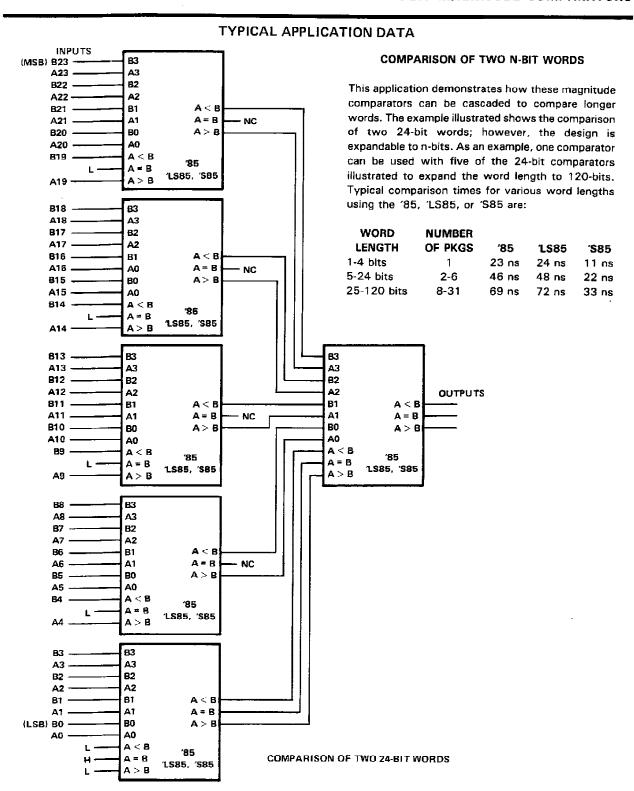
[¶]tpLH = propagation delay time, low-to-high-level output

NOTE 5: Load circuits and voltage waveforms are shown in Section 1.



[‡]All typical values are at V_{CC} = 5 V, T_A = 25°C. \$Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

tpHL = propagation delay time, high-to-low-level output



IMPORTANT NOTICE

Texas Instruments (TI) reserves the right to make changes to its products or to discontinue any semiconductor product or service without notice, and advises its customers to obtain the latest version of relevant information to verify, before placing orders, that the information being relied on is current.

TI warrants performance of its semiconductor products and related software to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

Certain applications using semiconductor products may involve potential risks of death, personal injury, or severe property or environmental damage ("Critical Applications").

TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, INTENDED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT APPLICATIONS, DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS.

Inclusion of TI products in such applications is understood to be fully at the risk of the customer. Use of TI products in such applications requires the written approval of an appropriate TI officer. Questions concerning potential risk applications should be directed to TI through a local SC sales office.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance, customer product design, software performance, or infringement of patents or services described herein. Nor does TI warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used.

Copyright © 1996, Texas Instruments Incorporated

IMPORTANT NOTICE

Texas Instruments and its subsidiaries (TI) reserve the right to make changes to their products or to discontinue any product or service without notice, and advise customers to obtain the latest version of relevant information to verify, before placing orders, that information being relied on is current and complete. All products are sold subject to the terms and conditions of sale supplied at the time of order acknowledgement, including those pertaining to warranty, patent infringement, and limitation of liability.

TI warrants performance of its semiconductor products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are utilized to the extent TI deems necessary to support this warranty. Specific testing of all parameters of each device is not necessarily performed, except those mandated by government requirements.

CERTAIN APPLICATIONS USING SEMICONDUCTOR PRODUCTS MAY INVOLVE POTENTIAL RISKS OF DEATH, PERSONAL INJURY, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE ("CRITICAL APPLICATIONS"). TI SEMICONDUCTOR PRODUCTS ARE NOT DESIGNED, AUTHORIZED, OR WARRANTED TO BE SUITABLE FOR USE IN LIFE-SUPPORT DEVICES OR SYSTEMS OR OTHER CRITICAL APPLICATIONS. INCLUSION OF TI PRODUCTS IN SUCH APPLICATIONS IS UNDERSTOOD TO BE FULLY AT THE CUSTOMER'S RISK.

In order to minimize risks associated with the customer's applications, adequate design and operating safeguards must be provided by the customer to minimize inherent or procedural hazards.

TI assumes no liability for applications assistance or customer product design. TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right of TI covering or relating to any combination, machine, or process in which such semiconductor products or services might be or are used. TI's publication of information regarding any third party's products or services does not constitute TI's approval, warranty or endorsement thereof.

Copyright © 1998, Texas Instruments Incorporated